



# Novel Cryogenic High Voltage Breaks (CHVB)

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Topic: 37c

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Energy to Power Solutions

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- e2P Overview
- Program Motivation
- Phase II Program Overview
- CHVB Schematic, Design, & Analysis
- CHVB Testing
- Commercial Outreach
- Path Forward

Energy to Power Solutions (e2P)- performs **early-stage R&D** of both Low Temperature Superconducting (LTS) & High Temperature Superconducting (HTS) devices, their associated cryogenics, and cryogenic High Voltage (HV) components → enabling technologies for **military, space, fusion energy, commercial & *medical application applications***



- **Founded 1999**
- ~50 % (US Govn't contracts) & ~50 % (commercial)
- Labs Located @ TCC in Tallahassee, FL





- Cryogenic High Voltage Breaks (CHV-Breaks) & Bushing (CHV-Bushings) electrically isolate cryogenic devices & equipment operating at High Voltages (HV) from grounded components & structures. CHV-Bushings also transmit electrical power into cryogenic space.
- State-of-the-Art (SOA) *ceramic* CHVB's are notoriously unreliable and prone to frequent *micro-cracking* & hence *leaking*.
- CHVB's leaking into cryogenic vacuum spaces can be prohibitively expensive to repair (e.g. ITER, CERN, etc.) or lead to premature failure (e.g. power equipment)
- For  $V_{op} > 100$  kV or non-magnetic there is no suitable commercial product
- **Requirements:** Low cost, mechanically robust, HV standoff, radiation resistant, hermetic, repeated thermal cycling, high internal pressure, non-magnetic

# Phase II Program Overview

## Work Scope A: Thermally Insulating CHVB for ANL w/ R. Vondasek

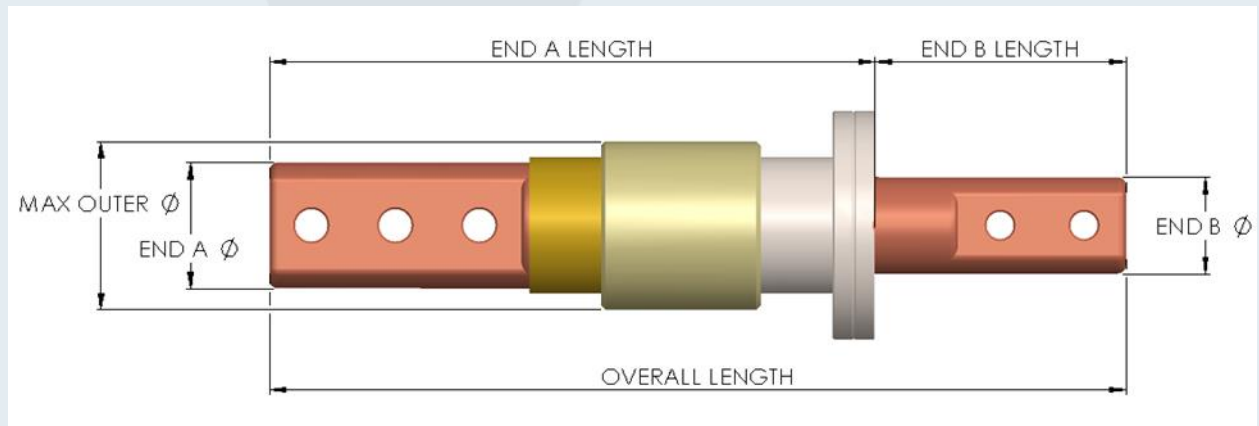
- $V_{op} > 150$  kV 
- Interior medium: flowing LN<sub>2</sub>, Exterior medium: atmosphere 
- Radiation: No
- Mechanical/Structural: NA
- Quantity: 2-3
- Commercial opportunity: Low

## Work Scope B: Radiation Tolerant CHVB for Commercial Fusion

- $V_{op} \sim 30$  kV
- Interior medium: GHe, Exterior medium: vacuum 
- Radiation: 10 MGy
- Mechanical/Structural: 500 PSI internal pressure 
- Quantity: > 1000
- Commercial Opportunity: Very high

## Work Scope C: General R&D for CHV-Bushing Design & Fabrication

- $V_{op\_DC} \sim 1 \rightarrow 5 \text{ kV}$  &  $V_{rms\_phase} 1 \rightarrow 15 \text{ kV}_{rms}$
- $I_{op\_DC} \sim 1 \rightarrow 10 \text{ kA}$  &  $I_{rms\_phase} 1 \rightarrow 5 \text{ kA}_{rms}$
- Interior medium: vacuum or cryogenic liquid
- Radiation: NA
- Mechanical/Structural: 100 PSI internal pressure
- Thermal cycles: > 100
- Quantity: > 20
- Commercial Opportunity: medium



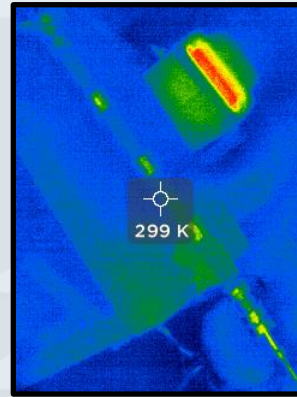
# CHVB Requirements

Properties		E2P CHVB	SOA Ceramic	PI Testing	PII Testing
<b>Electrical</b>	High Voltage >100kV	Green	Red		X
	Breakdown	Green	Green	X	
	Creep	Green	Green	X	
<b>Mechanical</b>	Thermal Cycling Resilience	Green	Red	X	X
	Compressive Strength	Green	Green	X	
	Tensile Strength	Green	Red		X
	Torsional Strength	Green	Red		X
	High Internal Pressure	Green	Yellow		X
<b>Other</b>	Hermetic	Green	Green	X	
	Accelerated Life*	Green	Red		X
	Non-magnetic	Green	Red	X	
	Radiation Resistance	Yellow	Green		X
	Low Cost	Green	Yellow		X

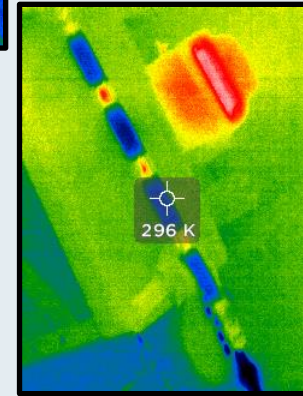
\*4 commercial orders

# Testing: Thermal Gradient

- LN<sub>2</sub> pumped through array over 15-minute period
- Thermal imaging used to capture thermal gradient and determine cold points
- Surfaces remained  $\geq 295\text{K}$  (reference device in background @  $\sim 318\text{K} \sim 45\text{C}$ )
- Device should not develop exterior surface condensation under expected conditions
- 2<sup>nd</sup> Gen unit needed for Grid applications



$T_1 = 299\text{K}$   
 $t_1 = 0\text{m}$



$T_5 = 296\text{K}$   
 $t_5 = 7\text{m}$



$T_8 = 295\text{K}$   
 $t_8 = 15\text{m}$   
 $T_{\text{ref}} = \sim 318\text{K}$





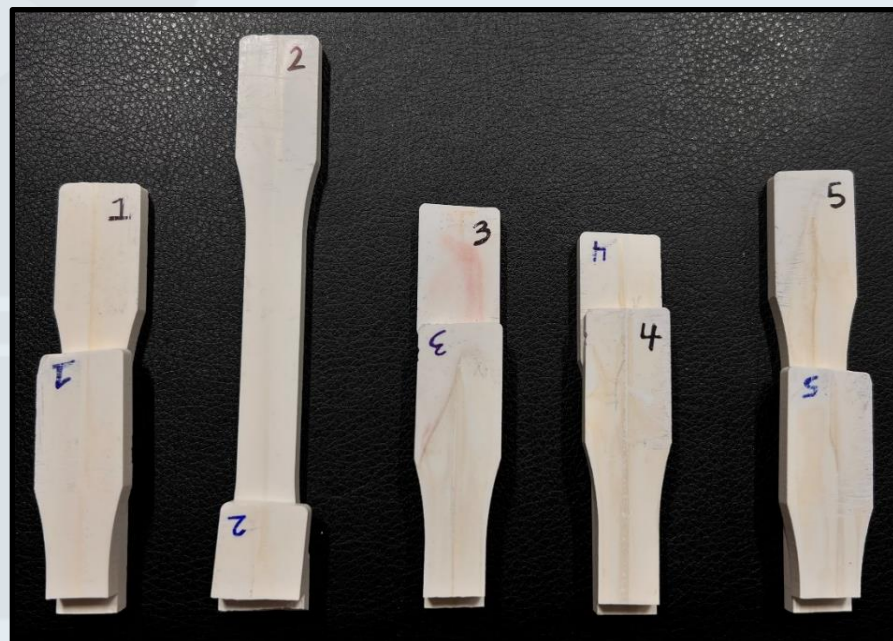
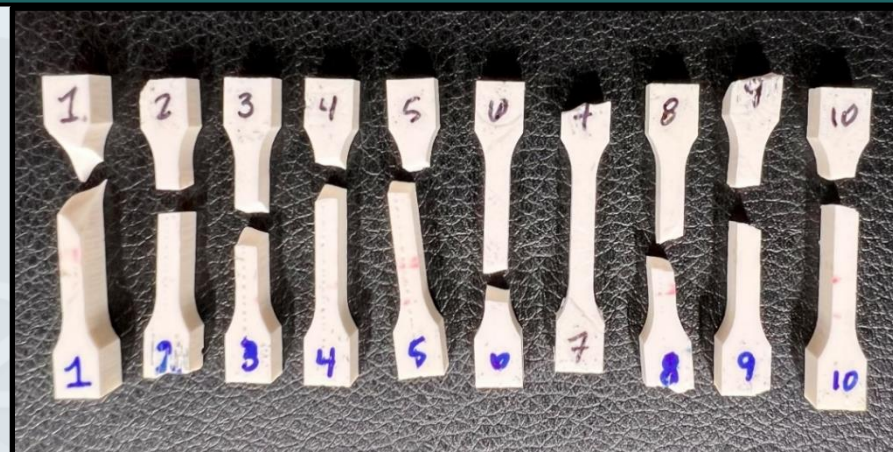
- Mechanical testing of:
  - Tensional Strength (ASTM D638)
  - Compressive Strength (ASTM E9)
  - Torsional Strength (ASTM D4065)
- ASTM compliant procedures include:
  - sample design
  - Fabrication
  - Testing
  - post-processing of data
- Procedures will be used to determine compliance of materials and components



## Mechanical Testing:

- Pictured top: Small form factor (SFF)<sup>1</sup> tension samples
- Pictured bottom: Large form factor (LFF) tension samples
- Both small and large samples utilize the same ASTM D638 & E9 “dog-bone” shape and proportions i.e. gauge<sup>2</sup> length is ~4x the gauge width

- 1) shape, proportions
- 2) reduced cross-sectional area section of sample



# Testing: Mechanical Data

UTS data for epoxy PEB-C

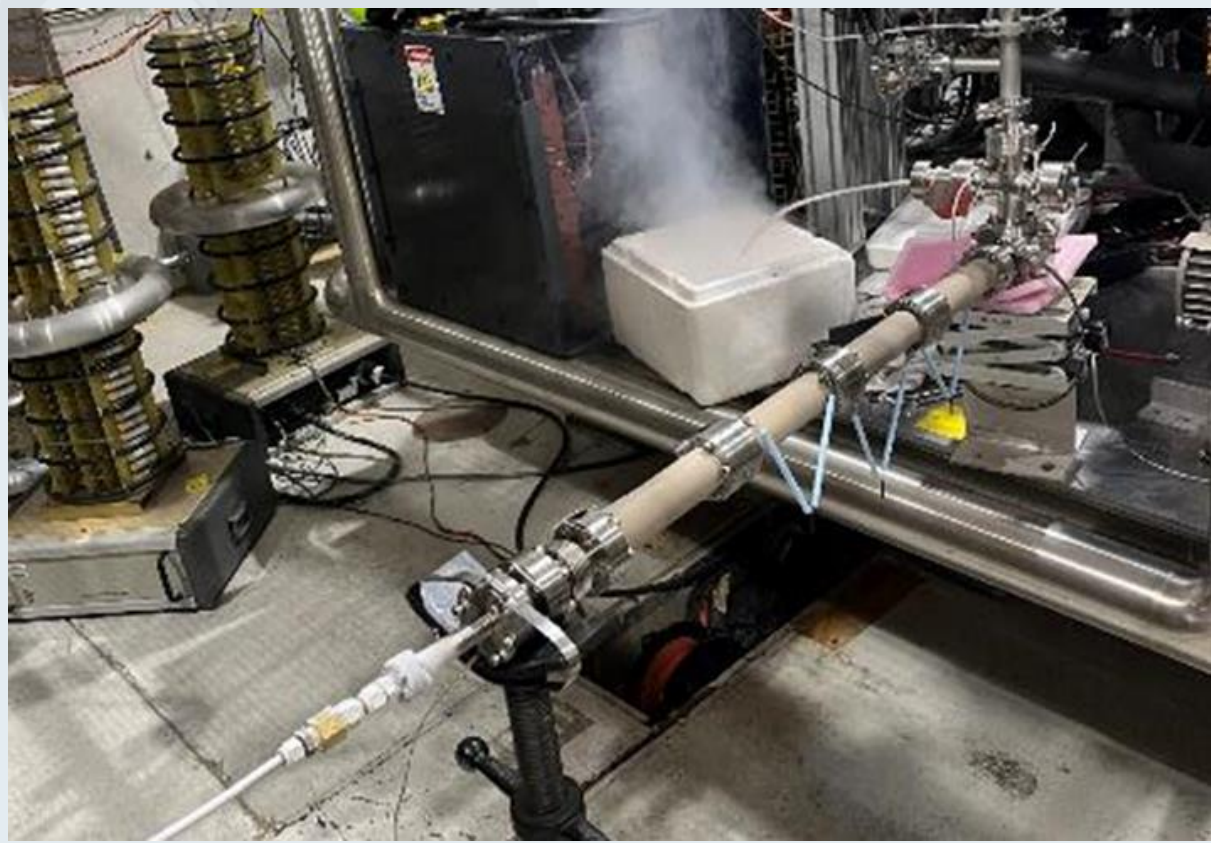
Results inconsistent: emphasizing need for process improvement

Sample	Ultimate Tensile Strength (MPa)	
	Small FF	Large FF
1	-	14.96
2	29.52	-
3	-	25.65
4	-	22.10
5	27.66	13.36
6	25.32	-
7	-	-
8	24.05	-
9	26.12	-
10	28.24	-
<b>Average ± Standard Deviation</b>	<b>26.82 ± 2.02 MPa</b>	<b>19.02 ± 5.82 MPa</b>

# CHVB Testing @ ANL

Test Conditions: flowing LN2 up to 2 L/min

Time (hh:mm)	Voltage (kV)	Current (mA)
13:40	50	0.26
13:45	75	0.44
13:48	90	0.54
13:50	100	0.60
13:55	100	0.60
13:56	110	0.69
14:00	110	0.69
14:35	120	0.76
14:40	130	0.86
14:47	140	0.95
14:56	150	1.05
15:01	150	1.05





- **Work scope A: >100 % complete**
  - Field test @ ANL (R. Vondrasek) → 100 %
  - $\Delta T_{OD} < 10$  K w/ LN2 @ 2 liters/min on interior up to 150 kV
- **Work scope B: Low Cost, High Throughput Manufacturing 100 % Complete !!**
  - Develop low-cost volume manufacturing techniques
  - Develop low-cost/repeatable/reliable high volume LN2 thermal cycle testing techniques
  - Develop low-cost/repeatable/reliable high volume GHe testing techniques
- **Work scope C: Component Test Multiple Prototypes**
  - Continue characterization
    - UTS
    - UCS
    - Torsional
    - Internal pressure to > 2000 PSI
    - Larger diameters up to 16 “
  - Expand into CHV-Bushings
    - DC – Magnet Applications
    - AC – Power Applications

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